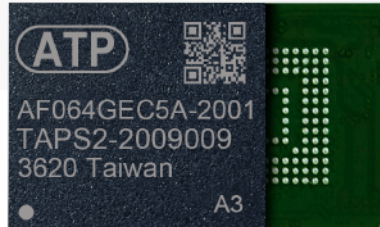




e.MMC Automotive

The Global Leader in Specialized Storage and Memory Solutions



KEY FEATURES

- AEC-Q100 Grade 2 (-40°C to 105°C), and Grade 3 (-40°C to 85°C) compliant*
- Robust Data Integrity* (AutoRefresh and Dynamic Data Refresh)
- Extra-high endurance: 2-3X higher than standard e.MMC*
- Complies with JEDEC e.MMC v5.1 Standard (JESD84-B51)
- 153-ball FBGA (RoHS compliant, "green package")
- LDPC ECC engine*

* May vary by product and project support

ATP Electronics shifts into high gear with automotive grade e.MMC solutions. These soldered-down solutions are constructed for maximum reliability on the road. They deliver consistent, stable performance amidst the challenging and unpredictable conditions that vehicles are commonly subjected to, such as intense shocks and vibrations, temperature variability, and constricted spaces. Infotainment systems, advanced driver assistance system (ADAS), telematics, and other automotive applications will benefit greatly from the extra-high endurance, which is 2-3X higher than standard e.MMC.

The automotive grade e.MMC solutions are compliant with AEC-Q100 and are available in two temperature grades for peace-of-mind journeys, whether in sub-zero winters or in scorching summers. Automotive Grade 3 (AG3) typically covers an operating range of -40°C to 85°C, while Automotive Grade 2 (AG2) offers an extended range for even more extreme conditions with elevated temperatures, from -40°C to 105°C.

ATP's automotive grade e.MMC solutions incorporate low-density parity-check error correction codes (LDPC ECC) to maintain data accuracy over their rated lifespan and beyond. AutoRefresh and Dynamic Data Refresh technologies prevent read disturb errors in often-accessed (hot zone) areas as well as seldom-accessed areas (cold zone).

| Technologies | S.M.A.R.T/ Life Monitor | Industrial Temperature | SjP | Vibration-Proof BGA Package | Firmware-Based Power Loss Protection | Advanced Wear Leveling | AutoRefresh | Dynamic Data Refresh | Auto-Read Calibration | ETEDP |
|--------------|----------------------------|---------------------------|-----|--------------------------------|--|---------------------------|-------------|-------------------------|--------------------------|-------|
| Premium | ○ | ○ | ○ | ○ | ○ | ○ | ○ | ○ | ▲ | ○ |
| Superior | ○ | ○ | ○ | ○ | ○ | ○ | ○ | ○ | ▲ | ○ |

▲: Customization option available on a project basis.

Specifications

| Product Line | Automotive Grade 2 | | | | Automotive Grade 3 | | | |
|---|-----------------------|--------------------|-------------------|-------------------|--------------------|--------------------|-------------------|-------------------|
| | Premium | | Superior | | Premium | | Superior | |
| | E700Paa | E700Paa | E600Saa | E600Saa | E700Pia | E700Pia | E600Sia | E600Sia |
| Flash Type | 3D MLC (pSLC mode) | 2D MLC (pSLC mode) | 3D MLC | 2D MLC | 3D MLC (pSLC mode) | 2D MLC (pSLC mode) | 3D MLC | 2D MLC |
| IC Package | 153-ball FBGA | | | | | | | |
| JEDEC Specification | v5.1, HS400 | | | | | | | |
| Power Loss Protection Options | Firmware Based | | | | | | | |
| Operating Temperature | -40°C to 105°C | | | | -40°C to 85°C | | | |
| Capacity ¹ | 8 GB to 64 GB | 4 GB to 8 GB | 16 GB to 128 GB | 8 GB to 16 GB | 8 GB to 64 GB | 4 GB to 8 GB | 16 GB to 128 GB | 8 GB to 16 GB |
| Performance | | | | | | | | |
| Sequential Read/Write up to (MB/s) ² | 300 / 240 | 230 / 100 | 300 / 170 | 230 / 100 | 300 / 240 | 230 / 100 | 300 / 170 | 230 / 100 |
| Bus Speed Modes | x1 / x4 / x8 | | | | | | | |
| ICC (Typical RMS in Read/Write) mA (Max.) | 145 / 175 | 85 / 65 | 125 / 175 | 85 / 50 | 145 / 175 | 85 / 65 | 125 / 175 | 85 / 50 |
| ICCQ (Typical RMS in Read/Write) mA (Max.) | 120 / 100 | 60 / 45 | 115 / 95 | 60 / 30 | 120 / 100 | 60 / 45 | 115 / 95 | 60 / 30 |
| Endurance and Reliability | | | | | | | | |
| Endurance TBW ² (Max.) | 1,213 TB | 200 TB | 824 TB | 40 TB | 1,213 TB | 200 TB | 824 TB | 40 TB |
| Reliability MTBF @ 25°C | >2,000,000 hours | >3,000,000 hours | >2,000,000 hours | >3,000,000 hours | >2,000,000 hours | >3,000,000 hours | >2,000,000 hours | >3,000,000 hours |
| Others | | | | | | | | |
| Dimensions (mm) | 11.5 x 13.0 x 1.3 | 11.5 x 13.0 x 1.0 | 11.5 x 13.0 x 1.3 | 11.5 x 13.0 x 1.0 | 11.5 x 13.0 x 1.3 | 11.5 x 13.0 x 1.0 | 11.5 x 13.0 x 1.3 | 11.5 x 13.0 x 1.0 |
| Certifications | AEC-Q100, RoHS, REACH | | | | | | | |
| Warranty | One Year | | | | | | | |

1 Low-density parity-check error correcting code. By product support.

2 All performance is collected or measured using ATP proprietary test environment, without file system overhead.



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WE BUILD WITH YOU

Product spec and its related information are subject to change without advance notice.

Please refer to www.atpinc.com for latest information

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